SN54F240, SN74F240 OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

SDFS061A - D2932, MARCH 1987 - REVISED OCTOBER 1993

20 VCC

19 20E

18 1Y1

17 2A4

16 1Y2

15 2A3

14 **1** 1Y3

13 1 2A2

12 1Y4

11 2A1

18 🚺 1Y1

17 🚺 2A4

16

15

14

1Y2

2A3

1Y3

SN54F240 ... FK PACKAGE

(TOP VIEW)

1A1 Vcc 20E

2 1 20 19

10 11 12 13

SN54F240 ... J PACKAGE

SN74F240 . . . DB, DW, OR N PACKAGE

(TOP VIEW)

10E

1A1 🚺 2

2Y4 🛛 3

1A2 4

2Y3 🚺 5

1A3 6

2Y2 **7**7

1A4 🛙 8

2Y1 🛛 9

GND 10

3

1A2 🛛 4

2Y3 🛮 5

- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- Package Options Include Plastic Small-Outline (SOIC) and Shrink Small-Outline (SSOP) Packages, Ceramic Chip Carriers, and Plastic and Ceramic DIPs

description

These octal buffers and line drivers are designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. Taken together with the 'F241 and 'F244, these devices provide the choice of selected combinations of inverting and noninverting outputs, symmetrical \overline{OE} (active-low output-enable) inputs, and complementary OE and \overline{OE} inputs.

The 'F240 is organized as two 4-bit buffers/line drivers with separate output enable (\overline{OE}) inputs. When \overline{OE} is low, the device passes data from the A inputs to the Y outputs. When \overline{OE} is high, the outputs are in the high-impedance state.

The SN74F240 is available in TI's shrink small-outline package (DB), which provides the same I/O pin count and functionality of standard small-outline packages in less than half the printed-circuit-board area.

The SN54F240 is characterized for operation over the full military temperature range of -55° C to 125°C. The SN74F240 is characterized for operation from 0°C to 70°C.

1A3 2Y2 1A4	9
	2Y1

FUNCTION TABLE
(each buffer)

INP	JTS	OUTPUT
OE	Α	Y
L	Н	L
L	L	н
Н	Х	Z

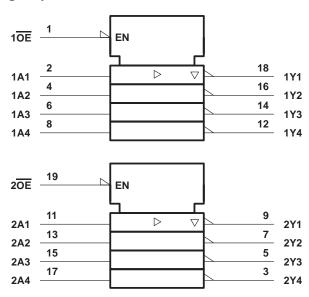
PRODUCTION DATA information is current as of publication date.
Products conform to specifications per the terms of Texas Instruments
standard warranty. Production processing does not necessarily include
esting of all parameters.

P P S te

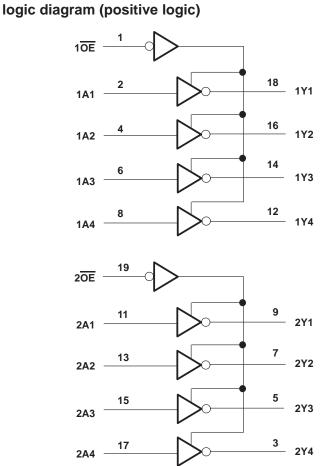


SN54F240, SN74F240 OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS SDFS061A – D2932, MARCH 1987 – REVISED OCTOBER 1993

logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[‡]

• · · ·		
Supply voltage range, V _{CC}		–0.5 V to 7 V
Input voltage range, VI (see Note 1) .		$\dots \dots \dots \dots \dots \dots \dots -1.2$ V to 7 V
Input current range		30 mA to 5 mA
Voltage range applied to any output in	the disabled or power-off state	\ldots -0.5 V to 5.5 V
Voltage range applied to any output in	the high state	$\dots \dots $
Current into any output in the low state	e: SN54F240	
	SN74F240	128 mA
Operating free-air temperature range:	SN54F240	–55°C to 125°C
	SN74F240	0°C to 70°C
Storage temperature range		–65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input voltage ratings may be exceeded provided the input current ratings are observed.



SN54F240, SN74F240 **OCTAL BUFFERS/DRIVERS** WITH 3-STATE OUTPUTS SDFS061A – D2932, MARCH 1987 – REVISED OCTOBER 1993

recommended operating conditions

		SN54F240			SN74F240			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.8			0.8	V
IIК	Input clamp current			-18			-18	mA
ЮН	High-level output current	- 12				- 15	mA	
IOL	Low-level output current	48				64	mA	
TA	Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETER	TEST CONDITIONS		s	SN54F240			SN74F240			
PARAMETER			MIN	TYP†	MAX	MIN	TYP†	MAX	UNIT	
VIK	V _{CC} = 4.5 V,	I _I = –18 mA			-1.2			-1.2	V	
		I _{OH} = – 3 mA	2.4	3.3		2.4	3.3			
Mari	$V_{CC} = 4.5 V$	I _{OH} = – 12 mA	2	3.2					v	
Voh		I _{OH} = – 15 mA				2	3.1		v	
	V _{CC} = 4.75 V,	I _{OH} = – 3 mA				2.7				
Ve		I _{OL} = 48 mA		0.38	0.55				V	
VOL	V _{CC} = 4.5 V	I _{OL} = 64 mA					0.42	0.55		
IOZH	V _{CC} = 5.5 V,	V _O = 2.7 V			50			50	μΑ	
IOZL	V _{CC} = 5.5 V,	V _O = 0.5 V			-50			-50	μΑ	
lı	V _{CC} = 5.5 V,	V _I = 7 V			0.1			0.1	mA	
Ιн	V _{CC} = 5.5 V,	V _I = 2.7 V			20			20	μΑ	
١ _{١L}	V _{CC} = 5.5 V,	V _I = 0.5 V			- 1			- 1	mA	
los‡	V _{CC} = 5.5 V,	$V_{O} = 0$	-100		-225	-100		-225	mA	
	V _{CC} = 5.5 V	Outputs high		19	29		19	29		
Icc		Outputs low		50	75		50	75	mA	
		Outputs disabled		42	63		42	63		

[†] All typical values are at V_{CC} = 5 V, T_A = 25°C.
[‡] Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.



switching characteristics (see Note 2)

PARAMETER	FROM (INPUT)	ТО (OUTPUT)	CI RI	CC = 5 V _ = 50 p _ = 500 s _ = 25°C	F, Ω,	CL RL	= 50 pF = 500 Ω		V,	UNIT
				′F240		′F240 SN54F240		SN74F240		
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
^t PLH	Any A	v	2.2	4.7	7	2.2	9	2.2	8	ns
^t PHL		ř	1.2	3.1	4.7	1.2	6	1.2	5.7	115
^t PZH	ŌĒ	Y	1.2	3.1	5.3	1.2	6.7	1.2	6.1	ns
^t PZL	UE UE	ř	3.2	6.5	9	3.2	10.5	3.2	10	115
^t PHZ	ŌĒ		1.2	3.6	5.3	1.2	6.5	1.2	6.3	ns
^t PLZ			1.2	5.6	8	1.2	12.5	1.2	9.5	115

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: Load circuits and waveforms are shown in Section 1.



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